

## TEGA Surface Phase Characterization Sample Acquire

### Activity Blocks Used:

Tega\_prep\_surface\_R5

Tega\_sample\_acquire R5

### Objectives:

This procedure turns on TEGA, prepares the instrument for the initial surface phase characterization sample, acquires sample delivered from the RA and closes the oven to TA #4.

**Configuration:** Landed Operations: Surface Phase Characterization. Instrument has gone through Checkout I, Checkout II Puncture seals, Cover retract has been complete and TA #4 door open has been completed and verified.

**Assumptions:** TEGA can not be turned on below -50C

**Gas(es) used:** Calibration and Carrier Gas Tanks have been punctured. No gases are flown during this activity.

**Filaments used:** 0

**SW Version (386):** V513

**SW Version (EGA):** V321

**Sweep and hop mode version(s):** **V112**

**Super modes and Sweep modes used:** None. The EGA is not ON during this activity.

1. Turn TEGA ON with tega\_power\_on (Controlled by interop)
  - 1.1. Add preheat pause as pass in duration determined by thermal environment
2. Call tega\_prep\_surface
  - 2.1. Execute Sequence 30A (turns down engineering readings)
    - 2.1.1. Pause for ~ 34 Minutes (set by interop/RA preparing sample)
3. Call tega\_sample\_acquire\_Select TA #4 : (Interop Calls this block)
  - 3.1.1. Call tega\_select\_oven (TWEAKABLE – NEED TO VERIFY TA#)

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3.1.2. Start solenoid shaker

3.1.3. Wait for oven Full: GV\_TEGA\_OVEN\_FULL has a timeout of 15 minutes

3.1.4. Close Oven – wait for GV\_TEGA\_TA\_DONE

3.1.5. Oven close time out is 20 minutes

4. Call tega\_power\_off\_Dump FPGA Registers

4.1. Main 3 Off

4.2. Main 2 Off

4.3. Main 1 Off